TWEPP-07 Topical Workshop on Electronics for Particle Physics

Wednesday, 5 September 2007

Plenary session P3 (09:00 - 10:30)

| time [id] title | presenter | |
|---|--------------------|--|
| 09:00 [108] Electronics and Sensor Study with the OKI SOI process | ARAI, Yasuo | |
| 09:45 [109] 3D System Integration for high density interconnects | Mr WIELAND, Robert | |